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Tailoring the thermal expansion of graphene via controlled defect creation



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ARTICLE INFO

Article history: Received 21 December 2016 Received in revised form 2 February 2017 Accepted 9 February 2017 Available online 13 February 2017

Keywords: Graphene Monovacancies Mechanical properties Molecular dynamics

ABSTRACT

Contrary to most materials, graphene exhibits a negative thermal expansion coefficient (TEC), i.e it contracts when heated. This contraction is due to the thermal excitation of low energy out—of—plane vibration modes. These flexural modes have been reported to govern the electronic transport and the mechanical response of suspended graphene. In this work, we systematically investigate the influence of defects in the TEC of suspended graphene membranes. Controlled introduction of low densities of monovacancies reduces the graphene TEC, up to one order of magnitude for a defect density of 5×10^{12} cm $^{-2}$. Our molecular dynamics simulations reproduce the observed trend and show that TEC reduction is due to the suppression of out—of—plane fluctuations caused by the strain fields created by mono-vacancies in their surrounding areas. These results highlight the key role of defects in the properties of "real-life" graphene, and pave the way for future proposals of electronic and mechanical defect engineering.

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1. Introduction

Graphene exhibits intrinsic out—of—plane thermal fluctuations that have dramatic effects on its conformation [1], electronic [2,3] and thermal transport properties [4], and on its elastic response [5]. One of the most prominent consequences of the presence of these flexural modes is the graphene large negative thermal expansion coefficient (TEC) [6–14]. The amplitude of these very soft acoustic ZA phonons rapidly increases with temperature and translates into an actual contraction of the material.

The thermodynamical theory of membranes predicts that out—of—plane thermal fluctuations should renormalize the elastic constants of graphene, making it softer as the amplitude of the fluctuations grows [5,15]. Lopez-Polin et al. [16] reported an

increase in the Young's modulus of graphene for a dilute density of single—atom vacancies. In order to address this counterintuitive result, these authors suggested, without further proof, that the induced defects ironed the thermal fluctuations out, unveiling the bare (non-renormalized) Young's modulus of graphene. This scenario implies that, not only the Young's modulus, but all the elastic constants should be affected by the presence of defects.

Graphene TEC is an ideal candidate to explore the interplay between intrinsic thermal vibrations and defects, and to confirm or reject the conjecture made in Ref. [16]. Moreover, this interaction is key to understand the physics underlying many temperature effects in real-life graphene, from the behavior of nanoresonators [17] to the diffusion of water nanodroplets on graphene [18]. However, measuring graphene TEC is a challenging task since conventional experimental techniques designed for bulk materials cannot be applied to such thin membranes, and the anchoring of one—atom—thick membranes brings out technological difficulties [19]. Therefore only few experimental works are available in literature [6,8].

Here, we showed that the graphene TEC can be significantly reduced by the controlled introduction of low densities of single-atom (mono-) vacancies. Our novel approach measures the TEC

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by the determination of the stress induced in a suspended graphene sheet due to the mismatch with the substrate TEC during annealing—cooling cycles. This stress was determined from nanoindentations performed with the tip of an atomic force microscope (AFM) on monolayered graphene drums. Our molecular dynamics (MD) simulations reproduced the observed trend, and revealed that TEC reduction is due to the quenching of out-of-plane fluctuations caused by the strain fields created by mono-vacancies.

2. Results and discussion

Experiments were performed on samples prepared by mechanical exfoliation of natural graphite on SiO_2/Si substrates with predefined circular wells with diameter of $1-2~\mu m$ (see Supplementary Information). Only monolayered graphene was selected for this study. Suspended circular membranes were tested by indenting the tip at the center of the clamped area with an AFM probe. This situation can be modeled as a circular membrane with a central point load where the force versus indentation curves behave as [20]:

$$F(\delta) = \pi \sigma_0 \delta + \frac{E_{2D}}{a^2} \delta^3 \tag{1}$$

where F is the loading force, δ is the indentation at the central point, a is the drumhead radius, E_{2D} is the two-dimensional elastic modulus of the membrane, and σ_0 is the stress of the membrane (both in N/m). Our $F(\delta)$ curves fitted correctly Eq. (1) (see Supplementary Fig. 2a) and our measured values in more than 10 drumheads for E_{2D} (350 \pm 30 N/m) and σ_0 (0.2 \pm 0.1 N/m) are in agreement with previous works [21,22]. The initial σ_0 reflects a small prestress accumulated in the sheet during the sample preparation procedure.

Towards thermo—mechanical characterization of graphene suspended layers, sample temperature was varied between 10 and 75° C and consecutive $F(\delta)$ curves were acquired at intermediate temperatures. Upon annealing, graphene tends to contract while the SiO_2 substrate shows negligible expansion [8]. This difference in behavior leads to an effective increase in the stress of the suspended graphene area that can be measured through the value of $\sigma_0(T)$ (see Fig. 1a and Fig. S2b). The use of the linear coefficient in Eq. (1) is indeed an experimental novelty since so far that equation was used to determine the Young's modulus of 2D materials through the coefficient of the cubic term. Green dots in Fig. 1b represent our measured σ_0 as a function of sample temperature for a representative pristine graphene drumhead. As expected, it displays an increasing stress with temperature. The two dimensional TEC (α_{2D}) of graphene can be directly calculated from this graph using:

$$\alpha_{2D} = -\left(\frac{\partial \varepsilon}{\partial T}\right)_{V} = -\frac{1}{E_{2D}} \left(\frac{\partial \sigma_{0}}{\partial T}\right)_{V},\tag{2}$$

where ε is the strain induced by temperature. Our measured mean value for the room temperature TEC in 7 pristine membranes, $(-7\pm1)\times10^{-6}~\text{K}^{-1}$, agrees with previous experimental reports [6,8] and supports the validity of our technique for the characterization of thermo-mechanical properties of suspended 2D materials.

In order to measure the variation of the graphene TEC in the presence of defects, a controlled density of point defects was then introduced in the membranes by irradiating the samples with a known dose of Ar⁺ with incoming energy of 140 eV in high vacuum. As reported in previous works by our group and others this technique allows the creation of controlled densities of carbon mono-

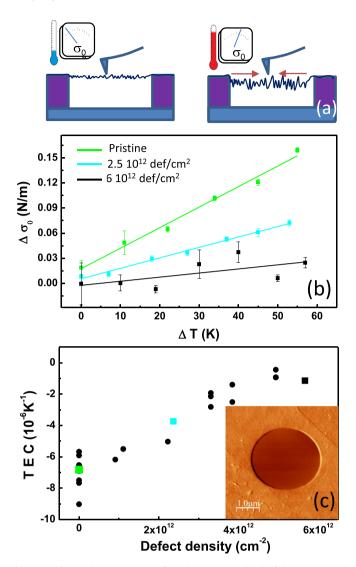


Fig. 1. Experimental measurements of graphene TEC. (a) Sketch of the experimental set-up. **(b)** Plot of measured stress as a function of sample temperature. Each color corresponds to a drumhead with a different defect density. Green: pristine. Blue: $2.5 \times 10^{12} \ \rm cm^{-2}$. Black: $6.0 \times 10^{12} \ \rm cm^{-2}$. **(c)** Experimentally measured TEC of different membranes as a function of the induced defect density. Inset: AFM image of a representative graphene drumhead. (A colour version of this figure can be viewed online.)

vacancies [16,23]: we carefully characterized the induced defect type and density by Raman spectroscopy and Scanning Tunneling Microscopy (STM) in ambient conditions as described in Ref. [16] and Section SI3 in the Supplementary Information: Both the ratio of the intensity of the I_D and $I_{D'}$ peaks [24,25] in the Raman spectra (Fig. S3), and the characteristic $\sqrt{3} \times \sqrt{3}$ pattern observed in the atomically resolved STM images [23] (Fig. S4) pointed towards clean single vacancies without sp³ hybridization. The I_D/I_G relation was used to determine the vacancy density. Consecutive low dose irradiations enable systematic study as a function of vacancy density.

Mechanical testing by indentation experiments was performed after each ionic dose with the same AFM probe and in the same conditions described above. The $F(\delta)$ curves in defective membranes displayed also excellent fitting to Eq. (1) allowing accurate determination of σ_0 (see Fig. S5). Fig. 1b illustrates our results for pristine and defective membranes. The stress of irradiated membranes do not increase as much as that of pristine membranes with

increasing temperature i.e. they exhibit a lower TEC in absolute value (hereafter referred as |TEC|). Systematic measurements in more than 10 graphene drumheads are represented in Fig. 1c. These results illustrate our main experimental finding: the high negative value of the TEC of graphene decreases with the introduction of vacancy-like defects, and approaches to zero ($\sim\!-1\times10^{-6}~\text{K}^{-1}$) for a defect density of $6\times10^{12}~\text{cm}^{-2}$ (corresponding to a mean distance between vacancies of $\sim\!4$ nm).

As an additional experiment to test our results through a more established approach, we performed AFM imaging of pristine and defective graphene drumheads before and after annealing-cooling cycles (Fig. 2). Suspended pristine graphene has been reported to undergo dramatic morphological changes under such cycles [6]. These changes comprise the appearance of periodic ripples, and the bending of graphene membranes towards the substrate. Both features are caused by the thermal stress induced in the membrane by the TEC mismatch between graphene and the SiO₂ substrate, which has a negligible TEC. In brief: during heating graphene tends to contract in plane in order to accomplish larger out-of plane thermal fluctuations. The in-plane strain towards the center of the well created by this contraction makes graphene slip on the substrate towards the well. Afterwards, upon cooling, graphene expands and the area of the membrane that slid away from the SiO₂ during heating is maintained inside the well and buckles towards the substrate. Therefore the difference in arc length inside the well before and after a heating-cooling cycle allows estimating the TEC of graphene. Our images of pristine graphene before and after an annealing-cooling cycle (in high vacuum) from 300 to 650 K showed these morphological changes. Representative images are portrayed in Fig. 2d and e, where periodic ripples in the radial direction and substantial buckling towards the substrate can be observed. Based on these images, the TEC of pristine graphene can be estimated according to: $\alpha_{2D} = \frac{L_f}{L_i \Delta T}$, where L_f and L_i are the final and initial arc of the membrane. The value derived from this

alternative methodology ($6.5 \times 10^{-6} \text{ K}^{-1}$) agrees well with that derived above and in previous reports [6]. We performed parallel AFM imaging before and after annealing-cooling cycles in membranes with a defect density of $6 \times 10^{12} \text{ cm}^{-2}$. In this case, we observe neither buckling nor periodic ripples (Fig. 2a and b), indicating that the TEC mismatch between the substrate and the graphene membrane approaches to zero i.e. a strongly reduced |TEC| in defective graphene, further supporting the results presented above.

As a first step to understand our measurements, we performed

constant pressure (NPT) MD simulations to determine the lattice parameter versus temperature for pristine and defective graphene (see Supplementary Information for further details on the simulations). Long (40 ns) simulations were performed in ~15 \times 15 nm² graphene slabs. Defects were created by single atom removal. Fig. 3a displays the results of these simulations for four different temperatures for pristine graphene (green) and two membranes with defect concentrations 2.22×10^{12} cm⁻² (purple circles) and 4×10^{12} cm⁻² (black circles). We can quantify the TEC using the linear fits shown in Fig. 3a and the standard TEC formula, $\alpha_{2D}=\frac{1}{l_0}\left(\frac{\partial l}{\partial T}\right)_p$. Our TEC for pristine graphene, (-3.27×10^{-6} K^{-1}), is in excellent agreement with previous ab initio [9] and classical-potential [10,13] theoretical studies. More importantly, our results for the defective systems (e.g. $-2.63 \times 10^{-6} \ K^{-1}$ for $4 \times 10^{12} \text{ cm}^{-2}$) show that the introduction of defects leads to a reduction of the |TEC|, in agreement with our experimental observations. Our results for different defect concentrations (Fig. 3b and Fig. S8) confirm the trend found in the experiments: the |TEC| decreases rapidly as the concentration of defect increases, and tends to saturate for concentrations beyond 4×10^{12} cm⁻². These results are robust with respect to the defect distribution and the number of sampling temperatures (see Fig. S9).

In order to understand the microscopic mechanism behind the TEC reduction, we explore the changes induced in the

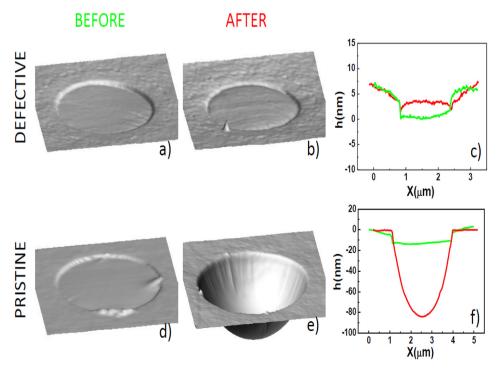


Fig. 2. AFM images on drumheads before and after an annealing-cooling cycle from 300 to 650 K. (a) and (b) panels correspond to a defective drumhead (defect density 6×10^{12} cm⁻²), while (d) and (e) are measured on a pristine graphene drumhead. Panels (c) and (f) are topographic profiles along the great arc of the drumheads before (green) and after (red) the annealing-cooling cycle. (A colour version of this figure can be viewed online.)

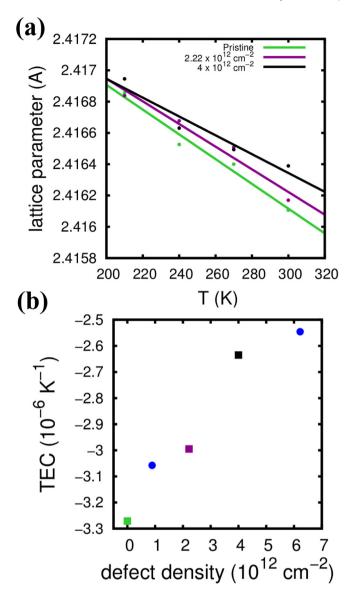


Fig. 3. Theoretical determination of the TEC from NPT simulations. (a) Lattice parameter versus temperature for pristine (green) and two defective graphene membranes with different defect concentration: $2.2 \times 10^{12} \, \mathrm{cm}^{-2}$ (purple), $4.0 \times 10^{12} \, \mathrm{cm}^{-2}$ (black). The TEC is determined by the slope of the corresponding linear fits (solid lines). (b) TEC as a function of the defect density. Data for $C_{def} = 4.0 \times 10^{12} \, \mathrm{cm}^{-2}$ is an average of four different defect configurations (see Supplementary Figs. 8b and 12). (A colour version of this figure can be viewed online.)

out—of—plane fluctuations by the combined effect of temperature and the presence of defects. Fig. 4a clearly shows the expected anticorrelation in the time evolution of the lattice parameter and the spatially averaged root—mean-square (RMS) amplitude for out—of—plane oscillations, h(t) (see Supplementary Information). More insight can be gained looking at the real space distribution (atom by atom) of the time averaged RMS amplitude of the out—of—plane fluctuations, $\langle h(\bar{r}_i) \rangle$ (with \bar{r}_i the xy in—plane position of atom i, see Supplementary Information), displayed in Fig. 4b for two different temperatures and in the presence of defects. These 2D maps capture two important features: First, for pristine graphene, the dominant red color at 300 K, in contrast to the blue color at 210 K, reflects that temperature is responsible for the increase in the amplitude of out—of—plane fluctuations for each atom, leading to an actual in—plane contraction of the material. Second, defective

graphene exhibits overall smaller fluctuations than pristine graphene. Although the atoms that are first neighbors of the defects have larger oscillation amplitudes, fluctuations have been drastically reduced on the rest of the graphene sheet, as shown by the dominance of grey color in the bottom left panel of Fig. 4b. This effect can be quantified using the line profiles shown in Fig. 4c and d. Summarizing, our simulations show that the TEC reduction in the presence of defects is induced by the reduction of out—of—plane fluctuations.

At this stage, we speculate that the quenching of out—of—plane fluctuations is linked with an additional in-plane stress induced in the graphene sheet by the defects. The presence of a uniform tensile strain is known to reduce the out-of-plane fluctuations [26]. We explored this idea with constant volume (NVT) MD simulations, that closely resemble the methodology used in our experiment, where graphene edges are clamped. NVT simulations were performed in the same range of temperatures and defect concentration used in the NPT case, using the lattice parameter obtained for pristine graphene at 210 K. Fig. 5a shows the converged thermal stress $\langle \sigma \rangle$ (see Fig. S10) for pristine and defective (4 \times 10¹² cm⁻²) graphene as a function of temperature. As in the experiments, the thermal stress of pristine graphene increases much faster than the defective one. This behavior, also observed for other defect densities (see Fig. S11), allows us to independently confirm that a decrease on the thermal strain indeed translates into a reduction of

In our classical simulations, we are able to decompose the total stress into a sum of local contributions for each of the carbon atoms (see Supplementary Information). Fig. 5b presents the time average of the sum of the in-plane diagonal components of the i-atom stress tensor $\langle K_{||}(\overline{r}_i) \rangle = \langle (K_{xx}(\overline{r}_i) + K_{yy}(\overline{r}_i))/2A_{at} \rangle$ as a 2D stress map for both pristine and defective graphene at two different temperatures. In-plane compressive (positive) stress is represented in red, while blue corresponds to in-plane tensile (negative) stress, that would tend to expand locally the graphene sheet. For pristine graphene at 210 K, we have an even distribution of very small regions with low positive and negative stress that cancel out. This result is consistent with the fact that the simulation box size is fixed to the equilibrium value of pristine graphene at 210 K. When temperature is raised to 300 K, the 2D stress map turns red, revealing a homogeneous increase of the in-plane compressive stress in the system (see Fig. 5c and d) as observed experimentally. This means that, if fixed boundary conditions were relaxed, graphene would shrink in-plane.

The 2D stress map for defective graphene at 210 K (see Fig. 5b) looks similar to the one of the pristine case in areas far from the defects (e.g., the left bottom corner). However, around defects, we observe a three-fold symmetry stress distribution, where areas of tensile (blue) and compressive (red) stress alternate. Overall, the map shows a predominance of blue areas with tensile stress. If fixed boundary conditions are released, this stress would favor an inplane expansion that naturally leads to a larger equilibrium lattice parameter for the defective case, in agreement with our NPT results (Fig. 3a). At 300 K, we observe an increase of the in-plane compressive stress similar to the one found in the pristine case. However, at variance with the latter, small patches of tensile stress can still be found around the defects. These patches are responsible for a reduction of the global compressive stress in the system, that would lead, if boundary conditions are removed, to a smaller in-plane contraction compared to the pristine case.

The maximum tensile stresses observed around defects for both temperatures (see Fig. 5c and d) are ~2.15 N/m, that corresponds to a local strain of 0.65%. Theoretical calculations based on the self-consistent screening approximation and atomistic MonteCarlo

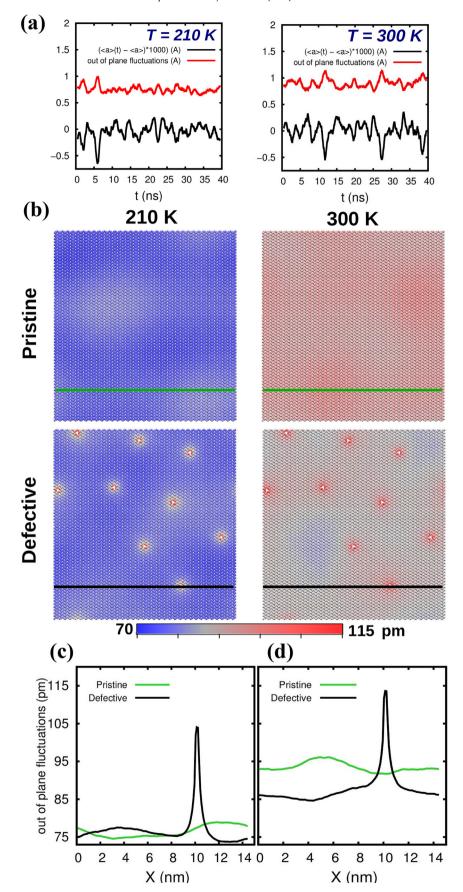


Fig. 4. Analysis of out-of-plane fluctuations in NPT simulations. (a)Time evolution of the spatially—averaged amplitude of the out—of-plane fluctuations h(t) (red), computed as described in the Supplementary Information, and the fluctuations of the lattice parameter (black) for the simulations at T=210 K and at T=300 K. (b) RMS amplitude of the out—of-plane fluctuation per atom, $\langle h(\bar{r}_i) \rangle$, (average of the z-coordinate of atom i over the last 20 ns) for pristine and defective $(4.0 \times 10^{12} \text{ cm}^{-2})$ graphene at two temperatures (T=210,300 K). (c) Profile of $\langle h(\bar{r}_i) \rangle$ along the green (black) line in panel (c) for pristine (defective) graphene at T=210 K. (d) Same as (c) for T=300 K. (A colour version of this figure can be viewed online.)

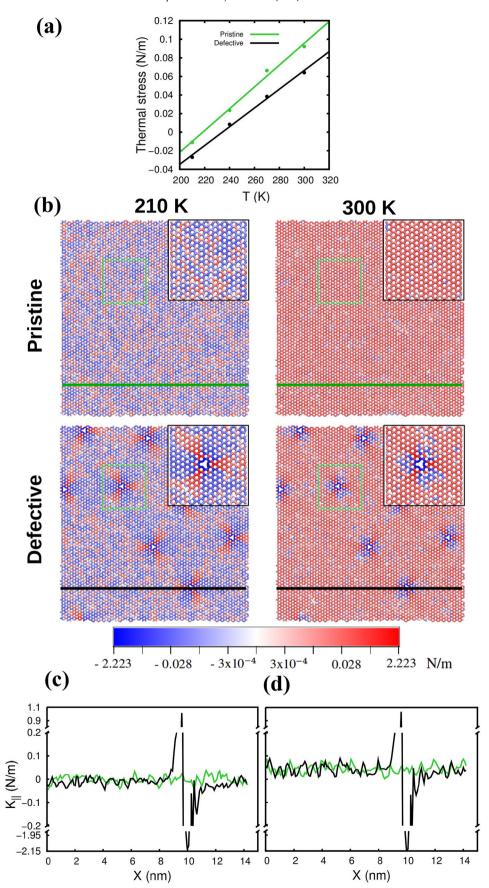


Fig. 5. Theoretical determination of the stress from NVT simulations. (a) Thermal stress versus temperature for pristine and defective $(4.0 \times 10^{12} \text{ cm}^{-2})$ graphene using the graphene lattice parameter at T = 210 K (b) Sum of the in–plane diagonal components of the i–atom stress tensor (normalized by the surface area per atom $A_{at} = 0.02529 \text{ nm}^2$) $\langle K_{\parallel}(\bar{r}_i) \rangle = \langle (K_{xx}(\bar{r}_i) + K_{yy}(\bar{r}_i))/2A_{at} \rangle$ for pristine and defective graphene at T = 210 K. (d)Same as (c) for T = 300 K. Notice the logarithmic scale used in panels (b)–(d). (A colour version of this figure can be viewed online.)

simulations [26], predict a very strong attenuation of the out of plane thermal fluctuations in stiff membranes, as graphene, with the presence of rather weak uniform strains (~0.4%). Strain fields less than 1% are enough to suppress all the anharmonic effects. This strong dependence with the strain provides the fundamental link between our results from the NPT and NVT simulations. Defects support short—wavelength normal vibrations, but the local strain that they induce contributes to the quenching of the long—wavelength thermal fluctuations that are mainly responsible for the in—plane graphene contraction. The remaining fluctuations lead to the reduced negative TEC measured in our experiments and simulations in the presence of defects. Thus, the stress distribution induced by the defects, in particular, the presence of areas of tensile stress, is responsible for the |TEC| reduction.

In spite of the remarkable agreement in experimental and simulated trends, there are quantitative discrepancies regarding the TEC for pristine graphene, where our theoretical results predict a TEC almost two times smaller than our experiments. This discrepancy has been already pointed out in previous experimental works [6,8]. According to recent MD simulations [13], |TEC| increases with system size for square $L \times L$ unit cells in the range $L\sim10-100$ nm. This behavior can be understood in terms of the effective cutoff introduced by the finite system size in the longwavelength out-of-plane vibration modes that are responsible for the negative TEC of graphene. This interpretation is consistent with the fact that experimental and theoretical values for the TEC in defective systems are much closer: For a defect density of 4×10^{12} cm⁻², the average TEC obtained in the experiments $(\sim\!\!-2.4\times10^{-6}~\text{K}^{-1})$ compares very well with our theoretical result $(\sim -2.63 \times 10^{-6} \text{ K}^{-1})$. According to our simulations (see Fig. 4b), the introduction of defects changes the TEC by reducing the average out—of—plane fluctuations. The suppression of these normal modes reduces the dependence on the system size and should bring a better theory-experiment agreement as we increase the defect concentration. This is precisely what we have found in our study, confirming our conclusions regarding the role of defects in tuning the TEC.

3. Conclusions

In summary, we have measured the TEC of graphene using a novel approach that can be extended to other 2D materials. We have shown that the TEC can be tuned through the controlled introduction of vacancy-like defects, reducing it to almost zero for a modest defect concentration (corresponding to a mean distance between vacancies of ~4 nm). Our long MD simulations reproduce this trend, validate the experimental approach, and provide a comprehensive understanding of this phenomenon in terms of the quenching of out-of-plane fluctuations induced by the patches of tensile strain introduced by the defects. Although the textbook physics of pristine graphene has attracted much attention, our work proves that the unavoidable presence of small defect densities in real-life graphene has profound implications. Our insight provides a guide for future proposals of either electronic or thermal defect engineering [27]. Along this line, we suggest controlled creation of low defect densities to reduce the TEC mismatch between graphene and substrates that cause undesired strains in devices. Our results have also to be considered in the interpretation of previous reports on the interplay of defects and mechanical properties. In particular, they constitute the first evidence supporting the conjecture of graphene stiffening by quenching of long-wavelength phonons by monovacancies [16] (see Fig. S6), paving the way for the tailoring of the mechanical properties of graphene and other 2D materials where out—of —plane thermal fluctuations are relevant.

Acknowledgement

We acknowledge financial support from the Spanish MINECO (projects CSD2010-00024, MAT2011-023627, MAT2016-77608-C3-3-P, MAT2014-54484-P, MDM-2014-0377, and FIS2015-69295-C3) and from the MAD2D-CM Program (project S2013/MIT-3007) of the Comunidad de Madrid. Computational resources provided by the Red Española de Supercomputación (RES) and the Extremadura Research Centre for Advanced Technologies (CETA-CIEMAT). We acknowledge fruitful discussions with Paco Guinea, Pablo San Jose, Lucia Rodrigo, Pablo Pou and Lars Pastewka.

Appendix A. Supplementary data

Supplementary data related to this article can be found at http://dx.doi.org/10.1016/j.carbon.2017.02.021.

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